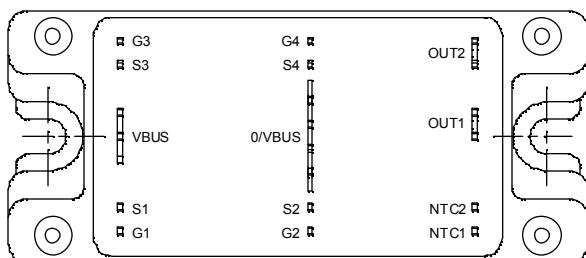
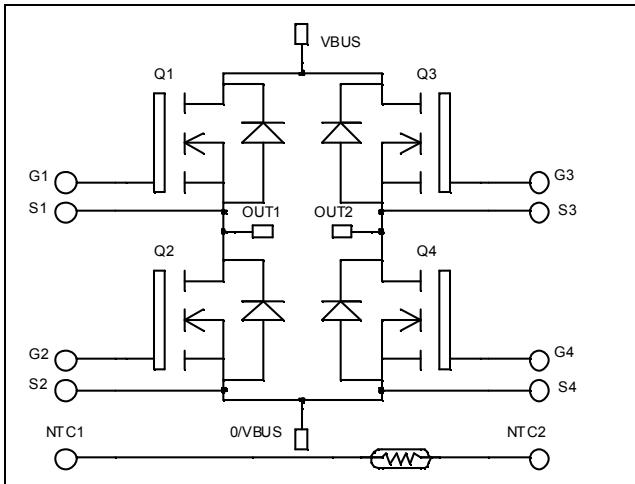




**Full - Bridge
MOSFET Power Module**

V_{DSS} = 200V
R_{DSon} = 20mΩ typ @ T_j = 25°C
I_D = 89A @ T_c = 25°C



Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies

Features

- Power MOS 7® FREDFETs
 - Low R_{DSon}
 - Low input and Miller capacitance
 - Low gate charge
 - Fast intrinsic reverse diode
 - Avalanche energy rated
 - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
 - Symmetrical design
 - Lead frames for power connections
- Internal thermistor for temperature monitoring
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- RoHS Compliant

Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V _{DSS}	Drain - Source Breakdown Voltage	200	V
I _D	Continuous Drain Current	T _c = 25°C	A
		T _c = 80°C	
I _{DM}	Pulsed Drain current	356	
V _{GS}	Gate - Source Voltage	±30	V
R _{DSon}	Drain - Source ON Resistance	24	mΩ
P _D	Maximum Power Dissipation	T _c = 25°C	W
I _{AR}	Avalanche current (repetitive and non repetitive)	89	A
E _{AR}	Repetitive Avalanche Energy	50	mJ
E _{AS}	Single Pulse Avalanche Energy	2500	

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
BV_{DSS}	Drain - Source Breakdown Voltage	$\text{V}_{\text{GS}} = 0\text{V}, \text{I}_D = 250\mu\text{A}$	200			V
I_{DSS}	Zero Gate Voltage Drain Current	$\text{V}_{\text{GS}} = 0\text{V}, \text{V}_{\text{DS}} = 200\text{V}$	$T_j = 25^\circ\text{C}$		250	μA
		$\text{V}_{\text{GS}} = 0\text{V}, \text{V}_{\text{DS}} = 160\text{V}$	$T_j = 125^\circ\text{C}$		1000	
$\text{R}_{\text{DS(on)}}$	Drain – Source on Resistance	$\text{V}_{\text{GS}} = 10\text{V}, \text{I}_D = 44.5\text{A}$		20	24	$\text{m}\Omega$
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{GS}} = \text{V}_{\text{DS}}, \text{I}_D = 2.5\text{mA}$	3		5	V
I_{GSS}	Gate – Source Leakage Current	$\text{V}_{\text{GS}} = \pm 30\text{ V}, \text{V}_{\text{DS}} = 0\text{V}$			± 100	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
C_{iss}	Input Capacitance	$\text{V}_{\text{GS}} = 0\text{V}$ $\text{V}_{\text{DS}} = 25\text{V}$ $f = 1\text{MHz}$		6850		pF
C_{oss}	Output Capacitance			2180		
C_{rss}	Reverse Transfer Capacitance			97		
Q_g	Total gate Charge	$\text{V}_{\text{GS}} = 10\text{V}$ $\text{V}_{\text{Bus}} = 100\text{V}$ $\text{I}_D = 75\text{A}$		112		nC
Q_{gs}	Gate – Source Charge			43		
Q_{gd}	Gate – Drain Charge			47		
$\text{T}_{\text{d(on)}}$	Turn-on Delay Time	Inductive switching @ 125°C $\text{V}_{\text{GS}} = 15\text{V}$ $\text{V}_{\text{Bus}} = 133\text{V}$ $\text{I}_D = 75\text{A}$		28		ns
T_r	Rise Time			56		
$\text{T}_{\text{d(off)}}$	Turn-off Delay Time			81		
T_f	Fall Time			99		
E_{on}	Turn-on Switching Energy	Inductive switching @ 25°C $\text{V}_{\text{GS}} = 15\text{V}, \text{V}_{\text{Bus}} = 133\text{V}$ $\text{I}_D = 75\text{A}, \text{R}_G = 5\Omega$		463		μJ
E_{off}	Turn-off Switching Energy			455		
E_{on}	Turn-on Switching Energy	Inductive switching @ 125°C $\text{V}_{\text{GS}} = 15\text{V}, \text{V}_{\text{Bus}} = 133\text{V}$ $\text{I}_D = 75\text{A}, \text{R}_G = 5\Omega$		608		μJ
E_{off}	Turn-off Switching Energy			531		

Source - Drain diode ratings and characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
I_S	Continuous Source current (Body diode)		$\text{T}_C = 25^\circ\text{C}$		89	A
			$\text{T}_C = 80^\circ\text{C}$		66	
V_{SD}	Diode Forward Voltage	$\text{V}_{\text{GS}} = 0\text{V}, \text{I}_S = - 75\text{A}$			1.3	V
dv/dt	Peak Diode Recovery ①				8	V/ns
t_{rr}	Reverse Recovery Time	$\text{I}_S = - 75\text{A}$ $\text{V}_R = 133\text{V}$ $\text{di}_S/\text{dt} = 100\text{A}/\mu\text{s}$	$\text{T}_j = 25^\circ\text{C}$		220	ns
			$\text{T}_j = 125^\circ\text{C}$		420	
Q_{rr}	Reverse Recovery Charge		$\text{T}_j = 25^\circ\text{C}$	1.07		μC
			$\text{T}_j = 125^\circ\text{C}$	2.9		

 ① dv/dt numbers reflect the limitations of the circuit rather than the device itself.

 $\text{I}_S \leq - 75\text{A}$ $\text{di}/\text{dt} \leq 700\text{A}/\mu\text{s}$ $\text{V}_R \leq \text{V}_{\text{DSS}}$ $\text{T}_j \leq 150^\circ\text{C}$



Thermal and package characteristics

Symbol	Characteristic		Min	Typ	Max	Unit
R _{thJC}	Junction to Case Thermal Resistance				0.35	°C/W
V _{ISOL}	RMS Isolation Voltage, any terminal to case t = 1 min, I isol<1mA, 50/60Hz	2500				V
T _J	Operating junction temperature range	-40		150		°C
T _{STG}	Storage Temperature Range	-40		125		
T _C	Operating Case Temperature	-40		100		
Torque	Mounting torque	To Heatsink	M5	2.5	4.7	N.m
Wt	Package Weight				160	g

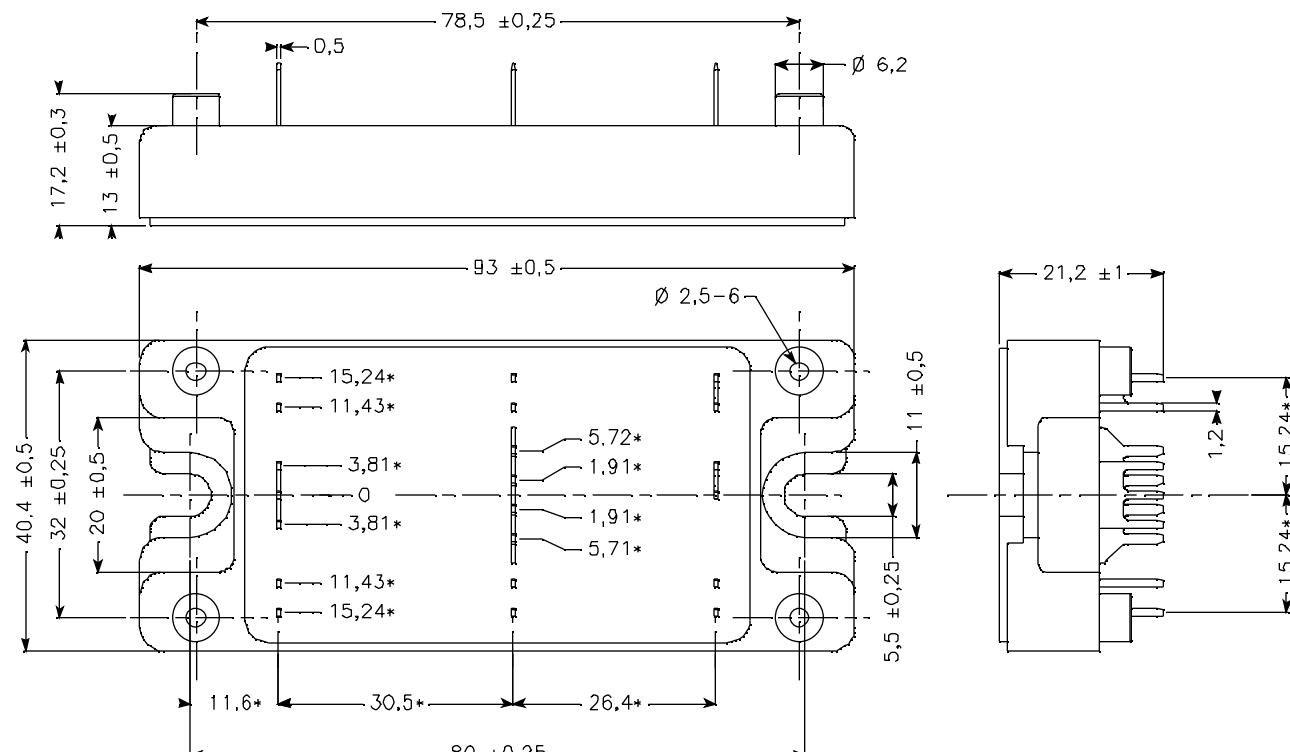
Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

Symbol	Characteristic		Min	Typ	Max	Unit
R ₂₅	Resistance @ 25°C			50		kΩ
B _{25/85}	T ₂₅ = 298.15 K			3952		K

$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]}$$

T: Thermistor temperature
R_T: Thermistor value at T

SP4 Package outline (dimensions in mm)

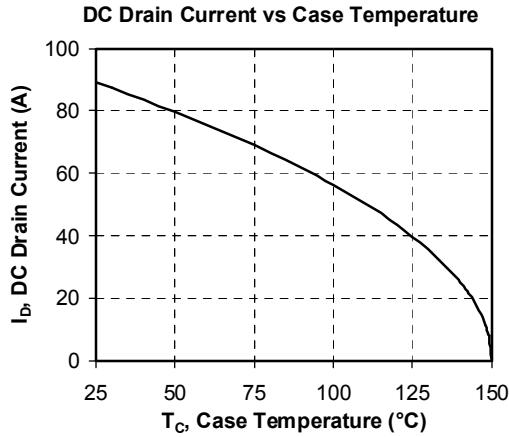
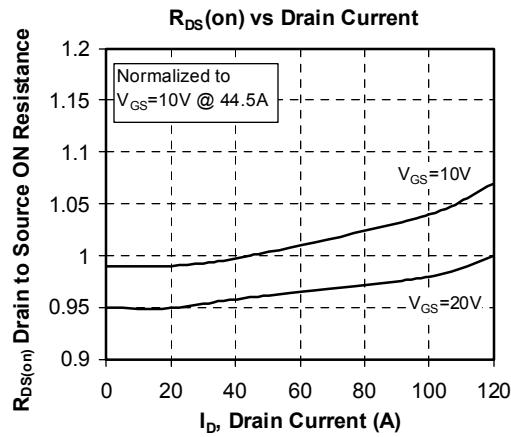
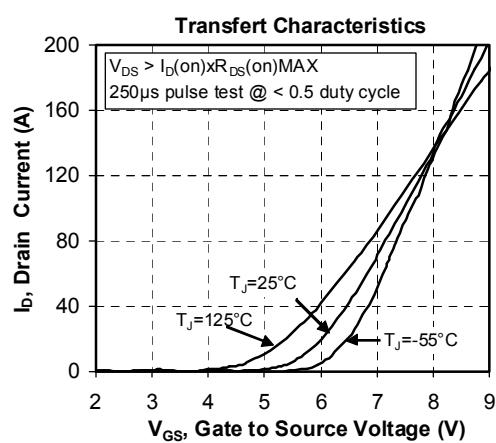
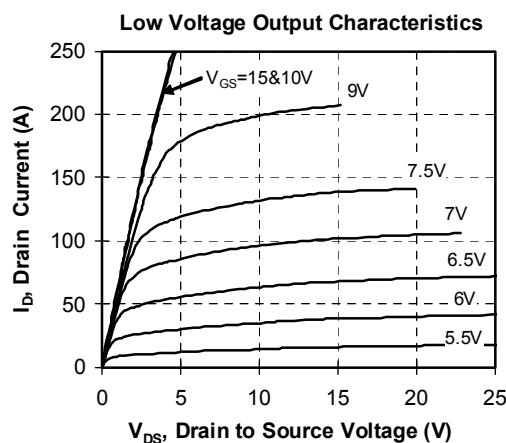
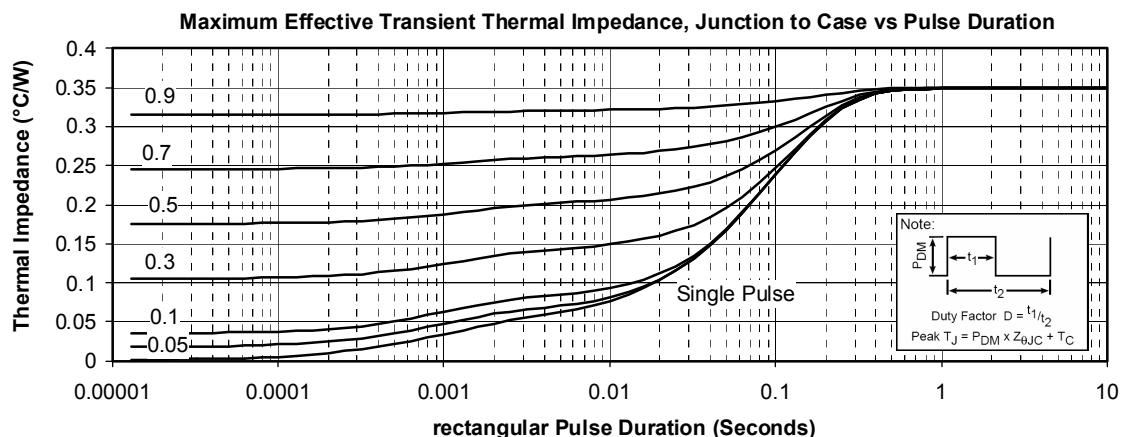


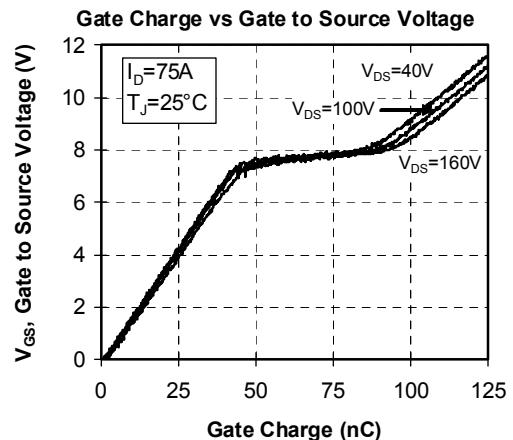
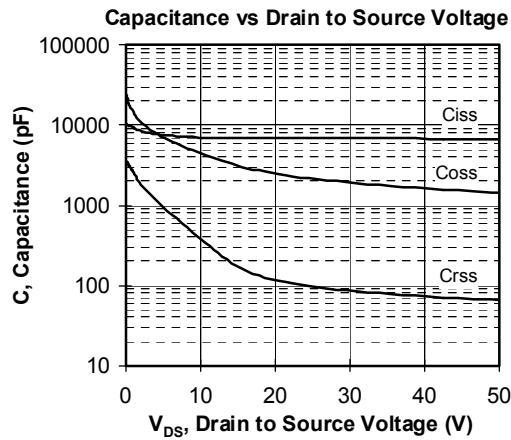
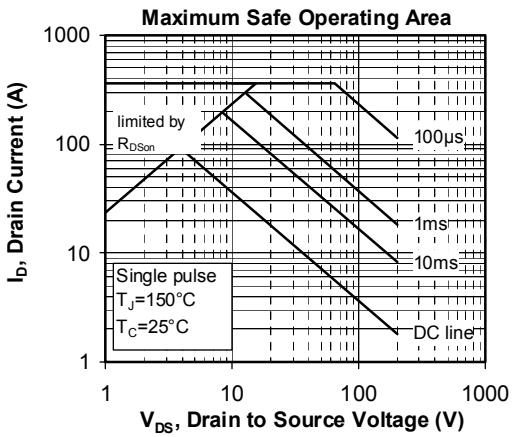
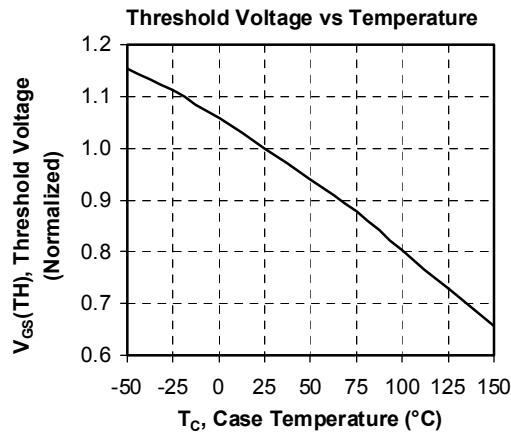
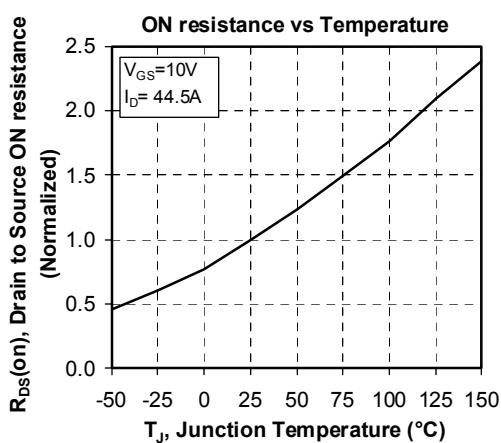
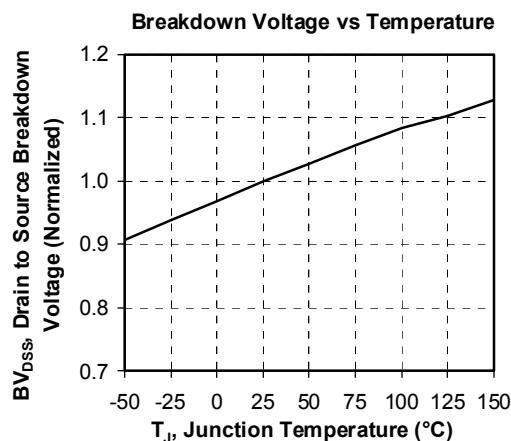
ALL DIMENSIONS MARKED " * " ARE TOLERENCED AS :

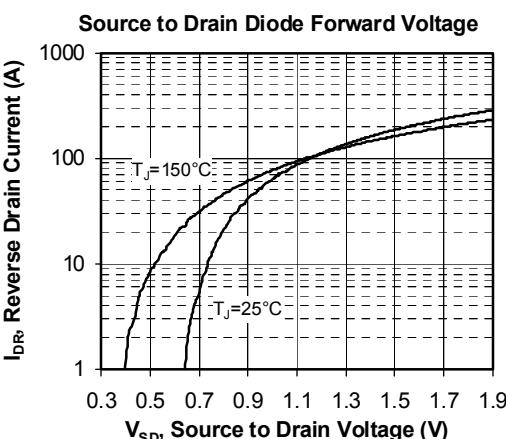
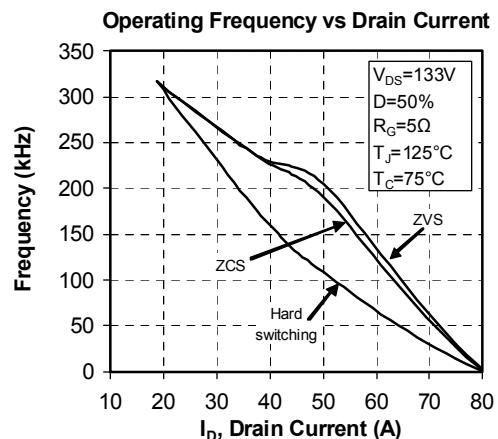
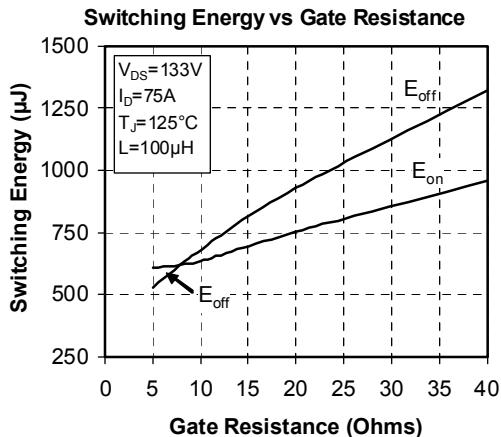
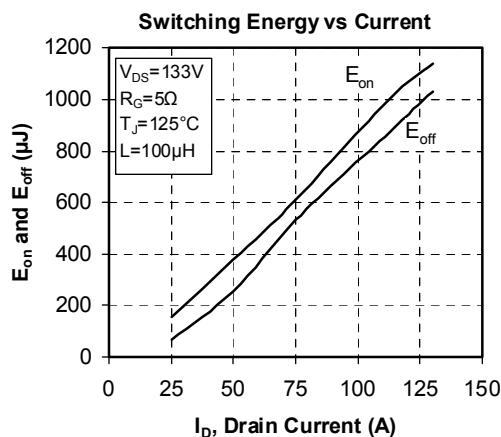
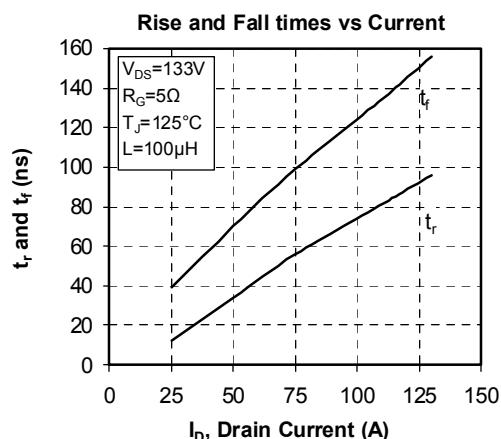
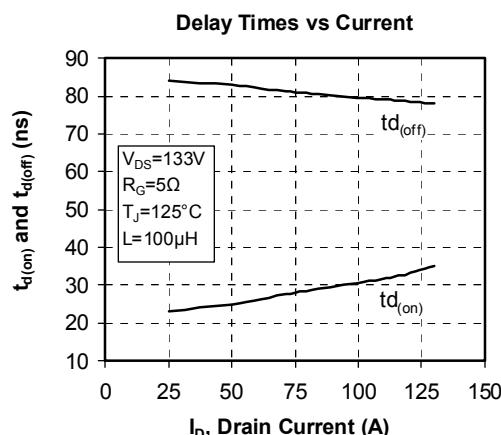
See application note APT0501 - Mounting Instructions for SP4 Power Modules on www.microsemi.com



Typical Performance Curve







Microsemi reserves the right to change, without notice, the specifications and information contained herein

Microsemi's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. U.S. and Foreign patents pending. All Rights Reserved.